



# Product Change Notification

## 113090 - 01

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# Product Change Notification

**Change Notification #:** 113090 - 01  
**Change Title:** Intel® Compute Module HNS2600JF  
PCN 113090-01, Product Material  
Update Integrated Baseboard Management  
Control (BMC) Chip  
**Reason for Revision: Update BMC chip  
revisions**  
**Date of Publication:** December 10, 2014

## Key Characteristics of the Change:

Product Material

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material *:</b>	Jul 15, 2014
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\* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

## Description of Change to the Customer:

**Reason for Revision: Update BMC chip revisions.**

Intel is implementing the following change on the Intel® Compute Module HNS2600JF:

1. The Integrated Baseboard Management Controller (BMC) chip has been updated to revision **A2**, because the previous revision **A1** is end of life. BMC **A1** cannot read data with 8-byte commands from the Field Replaceable Unit (FRU) on the IO module when enabling PCA9546 with more than one channel. The issue is fixed in BMC **A2**. Testing has been done and the functionality change is transparent to the customer.

## Customer Impact of Change and Recommended Action:

Intel anticipates no impact to customers. Customers may need to validate the function and feature changes after receiving the system.

## Products Affected / Intel Ordering Codes:

ASMO SKU			
Product Code	MM#	Pre Change TA	Post Change TA
HNS2600JF	918336	G51252-001	G51252-002

## PCN Revision History:

Date of Revision:	Revision Number:	Reason:
June 30, 2014	00	Originally Published PCN
December 10, 2014	01	<b>Update BMC chip revisions</b>